

Application Data Sheet
APPLICATION INFORMATION

Application Number::
Filing Date::
Application Type:: Regular
Subject Matter:: Utility
Suggested classification::
Suggested Group Art Unit::
CD-ROM or CD-R?:: None
Number of CD Disks:
Number of Copies of CDs::
Sequence Submission?::
Computer Readable From (CRF)?:: No
Number of Copies of CRF::
Title:: LEAD FORMING FOR A SEMICONDUCTOR
DEVICE
Attorney Docket Number:: 402698
Request for Early Publication?:: No
Request for Non-Publication?:: No
Suggested Drawing Figure::
Total Drawing Sheets:: 10
Small Entity?:: No
Latin Name::
Variety denomination name::
Petition Included?:: No
Petition Type::
Licensed US Govt. Agency::
Contract or Grant Numbers::
Secrecy Order in Parent Appl.?:: No

APPLICANT INFORMATION

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Hidetaka
Middle Name::
Family Name:: YAMASAKI
Name Suffix::
City of Residence:: Hyogo
State or Prov. of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o Renesas Device Design Corporation
61-5, Higashino 4-chome
City of mailing address:: Itami City
State or Province of mailing address:: Hyogo
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 664-0004

Inventor Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Itaru
Middle Name::
Family Name:: MATSUO
Name Suffix::
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Country of Residence:: Japan
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Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Hidekazu
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Family Name:: MANABE
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Inventor Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Kenji
Middle Name::
Family Name:: IMAMURA
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Country of Residence:: Japan
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Applicant Authority Type:: Inventor
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Given Name:: Kenichirou
Middle Name::
Family Name:: KATOU
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Inventor Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Mitsutaka
Middle Name::
Family Name:: MATSUO
Name Suffix::
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State or Prov. of Residence::
Country of Residence:: Japan
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CORRESPONDENCE INFORMATION

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REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2003-1242	01/07/03	Yes

ASSIGNEE INFORMATION

Assignee name:: Renesas Technology Corp.

Street of mailing address:: 4-1, Marunouchi 2-chome
Chiyoda-ku

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State or Province of
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Assignee name:: Renesas Device Design Corporation

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